

PCF8534

Universal LCD driver for low multiplex rates

Rev. 00.05 — 20 February 2007

Preliminary datasheet

General description 1.

The PCF8534 is a peripheral device which interfaces to almost any Liquid Crystal Display (LCD) with low multiplex rates. It generates the drive signals for any static or multiplexed LCD containing up to four backplanes and up to 60 segments and can easily be cascaded for larger LCD applications. The PCF8534 is compatible with most microprocessors / microcontrollers and communicates via a two-line bidirectional I²C-bus. Communication overheads are minimized using a display RAM with auto-incremented addressing, hardware subaddressing and display memory switching (static and duplex drive modes).

2. **Features**

- Single-chip LCD controller / driver
- Selectable display bias configuration: static, $\frac{1}{2}$ or $\frac{1}{3}$
- 60 segment drives: up to thirty 8-segment numeric characters; up to sixteen 15-segment alphanumeric characters; or any graphics of up to 240 elements
- Auto-incremented display data loading across device subaddress boundaries
- Versatile blinking modes
- Wide power supply range: from 1.8 to 5.5 V
- Low power consumption
- TTL/CMOS compatible
- May be cascaded for 2 LCD applications
 No external components
- Manufactured in silicon gate CMOS process.

- Selectable backplane drive configuration: static or 2/3/4 backplane multiplexing
- Internal LCD bias generation with voltage-follower buffers
- 60 x 4-bit RAM for display data storage
- Display memory bank switching in static and duplex drive modes
- LCD and logic supplies may be separated
- Wide LCD supply range: from 2.5 V for low threshold LCDs and up to 6.5 V for guest-host LCDs and high threshold (automobile) twisted nematic LCDs
- 400 kHz I²C-bus interface
- Compatible with 4-bit, 8-bit or 16-bit microprocessors/microcontrollers



www.DataSheet4U.com

Universal LCD driver for low multiplex rates

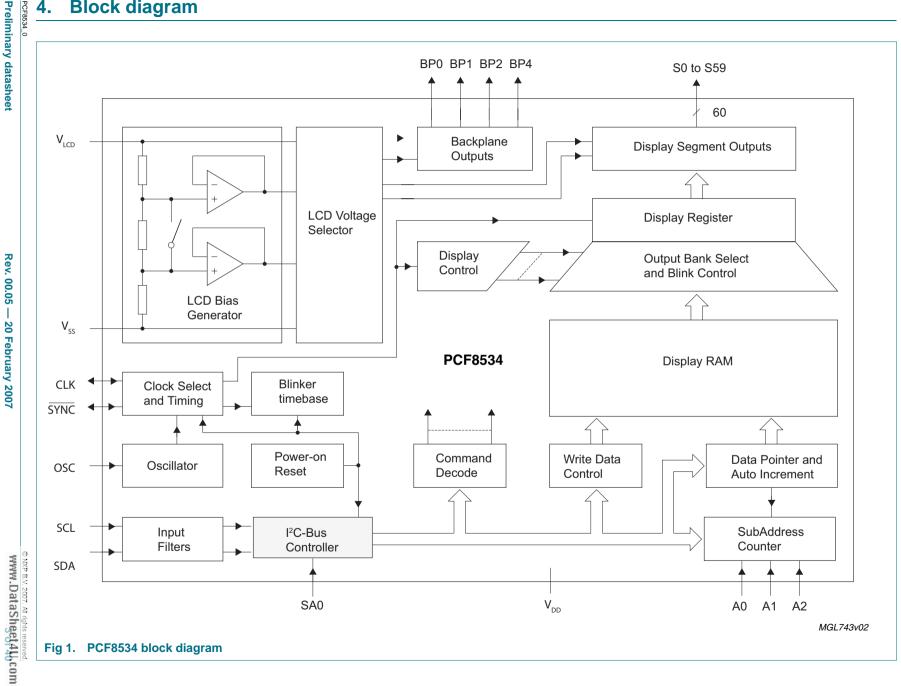
3. Ordering information

Table 1. Ordering information

Type number	Topside	Package	ckage					
	mark	Name	Description	Version				
PCF8534H	PCF8534H	LQFP80	plastic, low profile, quad flat package; 80 leads; body 12 x 12 x 1.4 mm	SOT315-1				

www.DataSheet4U.com

Block diagram



www.DataSheet4U.com

Universal LCD driver for low multiplex rates

5. Pinning information

5.1 Pinning

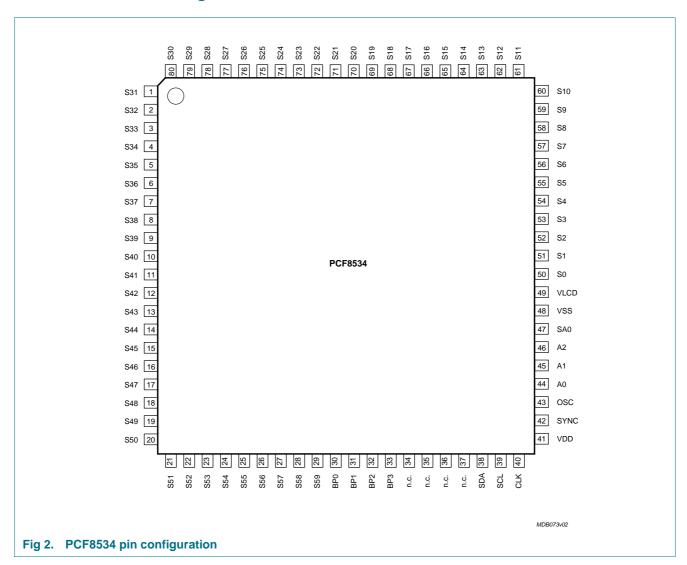


Table 2. Pin allocation table

Pin	Symbol	Pin	Symbol
1	S31	41	V_{DD}
2	S32	42	SYNC
3	S33	43	OSC
4	S34	44	A0
5	S35	45	A1
6	S36	46	A2
7	S37	47	SA0
8	S38	48	V _{SS}
9	S39	49	V _{LCD}

Table 2. Pin allocation table ...continued

10 S40 50 S0 11 S41 51 S1 12 S42 52 S2 13 S43 53 S3 14 S44 54 S4 15 S45 55 S5 16 S46 56 S6 17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 <th>Pin</th> <th>Symbol</th> <th>Pin</th> <th>Symbol</th>	Pin	Symbol	Pin	Symbol
11 S41 51 S1 12 S42 52 S2 13 S43 53 S3 14 S44 54 S4 15 S45 55 S5 16 S46 56 S6 17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BPO 70 S20 31 BP1 71 S21 32 BP2 72 S22 <td></td> <td>-</td> <td></td> <td></td>		-		
12 S42 52 S2 13 S43 53 S3 14 S44 54 S4 15 S45 55 S5 16 S46 56 S6 17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BPO 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 </td <td></td> <td></td> <td></td> <td></td>				
13 S43 53 S3 14 S44 54 S4 15 S45 55 S5 16 S46 56 S6 17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24				
14 S44 54 S4 15 S45 55 S5 16 S46 56 S6 17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25				
16 S46 56 S6 17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 <td></td> <td></td> <td></td> <td></td>				
17 S47 57 S7 18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S29 <td>15</td> <td>S45</td> <td>55</td> <td>S5</td>	15	S45	55	S5
18 S48 58 S8 19 S49 59 S9 20 S50 60 S10 21 S51 61 S11 22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S29	16	S46	56	S6
19 \$49 59 \$9 20 \$50 60 \$10 21 \$51 61 \$11 22 \$52 62 \$12 23 \$53 63 \$13 24 \$54 64 \$14 25 \$55 65 \$15 26 \$56 66 \$16 27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$PO 70 \$20 31 \$P1 71 \$21 32 \$P2 72 \$22 33 \$P3 73 \$23 34 n.c. 74 \$24 35 n.c. 75 \$25 36 n.c. 76 \$26 37 n.c. 77 \$27 38 \$DA 78 \$29	17	S47	57	S7
20 \$50 60 \$10 21 \$51 61 \$11 22 \$52 62 \$12 23 \$53 63 \$13 24 \$54 64 \$14 25 \$55 65 \$15 26 \$56 66 \$16 27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$P0 70 \$20 31 \$P1 71 \$21 32 \$P2 72 \$22 33 \$P3 73 \$23 34 n.c. 74 \$24 35 n.c. 75 \$25 36 n.c. 76 \$26 37 n.c. 77 \$27 38 \$DA 78 \$29	18	S48	58	S8
21 \$51 61 \$11 22 \$52 62 \$12 23 \$53 63 \$13 24 \$54 64 \$14 25 \$55 65 \$15 26 \$56 66 \$16 27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$P0 70 \$20 31 \$P1 71 \$21 32 \$P2 72 \$22 33 \$P3 73 \$23 34 n.c. 74 \$24 35 n.c. 75 \$25 36 n.c. 76 \$26 37 n.c. 77 \$27 38 \$DA 78 \$29	19	S49	59	S9
22 S52 62 S12 23 S53 63 S13 24 S54 64 S14 25 S55 65 S15 26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S28 39 SCL 79 S29	20	S50	60	S10
23 \$53 63 \$13 24 \$54 64 \$14 25 \$55 65 \$15 26 \$56 66 \$16 27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$P0 70 \$20 31 \$BP1 71 \$21 32 \$BP2 72 \$22 33 \$BP3 73 \$23 34 \$n.c. 74 \$24 35 \$n.c. 75 \$25 36 \$n.c. 76 \$26 37 \$n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	21	S51	61	S11
24 \$54 64 \$14 25 \$55 65 \$15 26 \$56 66 \$16 27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$P0 70 \$20 31 \$P1 71 \$21 32 \$P2 72 \$22 33 \$P3 73 \$23 34 \$n.c. 74 \$24 35 \$n.c. 75 \$25 36 \$n.c. 76 \$26 37 \$n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	22	S52	62	S12
25 \$55 65 \$15 26 \$56 66 \$16 27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$P0 70 \$20 31 \$P1 71 \$21 32 \$P2 72 \$22 33 \$P3 73 \$23 34 \$n.c. 74 \$24 35 \$n.c. 75 \$25 36 \$n.c. 76 \$26 37 \$n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	23	S53	63	S13
26 S56 66 S16 27 S57 67 S17 28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S28 39 SCL 79 S29	24	S54	64	S14
27 \$57 67 \$17 28 \$58 68 \$18 29 \$59 69 \$19 30 \$P0 70 \$20 31 \$P1 71 \$21 32 \$P2 72 \$22 33 \$P3 73 \$23 34 \$n.c. 74 \$24 35 \$n.c. 75 \$25 36 \$n.c. 76 \$26 37 \$n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	25	S55	65	S15
28 S58 68 S18 29 S59 69 S19 30 BP0 70 S20 31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S28 39 SCL 79 S29	26	S56	66	S16
29 \$59 69 \$19 30 \$BP0 70 \$20 31 \$BP1 71 \$21 32 \$BP2 72 \$22 33 \$BP3 73 \$23 34 \$n.c. 74 \$24 35 \$n.c. 75 \$25 36 \$n.c. 76 \$26 37 \$n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	27	S57	67	S17
30 BP0 70 \$20 31 BP1 71 \$21 32 BP2 72 \$22 33 BP3 73 \$23 34 n.c. 74 \$24 35 n.c. 75 \$25 36 n.c. 76 \$26 37 n.c. 77 \$27 38 SDA 78 \$28 39 SCL 79 \$29	28	S58	68	S18
31 BP1 71 S21 32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S28 39 SCL 79 S29	29	S59	69	S19
32 BP2 72 S22 33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S28 39 SCL 79 S29	30	BP0	70	S20
33 BP3 73 S23 34 n.c. 74 S24 35 n.c. 75 S25 36 n.c. 76 S26 37 n.c. 77 S27 38 SDA 78 S28 39 SCL 79 S29	31	BP1	71	S21
34 n.c. 74 \$24 35 n.c. 75 \$25 36 n.c. 76 \$26 37 n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29				
35 n.c. 75 \$25 36 n.c. 76 \$26 37 n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	33	BP3	73	S23
36 n.c. 76 \$26 37 n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29	34	n.c.	74	
37 n.c. 77 \$27 38 \$DA 78 \$28 39 \$CL 79 \$29		n.c.		
38 SDA 78 S28 39 SCL 79 S29		n.c.		
39 SCL 79 S29				
40 CLK 80 S30	40	CLK	80	S30

5.2 Pin description

Table 3. Pin description

· ·		
Symbol	Pin	Description
SDA	38	I ² C-bus serial data input / output
SCL	39	I ² C-bus serial clock input
CLK	40	external clock input / output
V_{DD}	41	supply voltage
SYNC	42	cascade synchronization input / output

Universal LCD driver for low multiplex rates

Table 3. Pin description

Symbol	Pin	Description
OSC	43	internal oscillator enable input
A0, A1 and A2	44 to 46	subaddress inputs
SA0	47	I ² C-bus slave address input: [0]
V _{SS}	48	logic ground
V _{LCD}	49	LCD supply voltage
BP0, BP1, BP2 and BP3	30 to 33	LCD backplane outputs
S0 to S59	50 to 80 and 1 to 29	LCD segment outputs

6. Functional description

The PCF8534 is a versatile peripheral device designed to interface any microprocessor/microcontroller to a wide variety of LCDs. It can directly drive any static or multiplexed LCD containing up to four backplanes and up to 60 segments. The display configurations possible with the PCF8534 depend on the number of active backplane outputs required; a selection of display configurations is given in Table 4.

All of the display configurations given in $\underline{\text{Table 4}}$ can be implemented in the typical system shown in Figure 3.

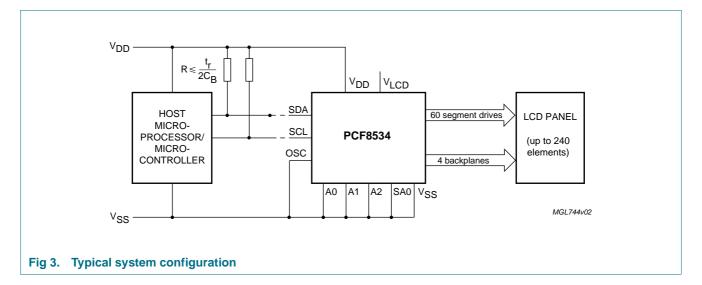
The host microprocessor / microcontroller maintains the 2-line I^2C -bus communication channel with the PCF8534. The internal oscillator is selected by connecting pad OSC to V_{SS} . The appropriate biasing voltages for the multiplexed LCD waveforms are generated internally. The only other connections required to complete the system are the power supplies (V_{DD} , V_{SS} and V_{LCD}) and the LCD panel selected for the application.

Table 4. Selection of display configurations

Number of		7 segment	numeric	14 segment n	umeric	Dot matrix
Backplanes	Segments	Digits	Indicator symbols	Characters	Indicator symbols	
4	240	30	30	16	16	240 (4 x 60)
3	180	22	26	12	12	180 (3 x 60)
2	120	15	15	8	8	120 (2 x 60)
1	60	7	11	4	4	60 (1 x 60)

NXP Semiconductors

Universal LCD driver for low multiplex rates



6.1 Power-on-reset

At power on the PCF8534 resets to a starting condition as follows:

- 1. All backplane outputs are set to V_{I CD}.
- 2. All segment outputs are set to V_{LCD}.
- 3. The drive mode '1 : 4 multiplex with $\frac{1}{3}$ bias' is selected.
- 4. Blinking is switched off.
- 5. Input and output bank selectors are reset (as defined in Table 7 old datasheet).
- 6. The I²C-bus interface is initialized.
- 7. The data pointer and the subaddress counter are cleared.
- 8. Display disabled.

You must avoid data transfers on the I²C-bus for 1 ms following power on to allow the reset action to complete.

6.2 LCD bias generator

Fractional LCD biasing voltages are obtained from an internal voltage divider of the three series resistors connected between V_{LCD} and V_{SS}. The centre resistor can be switched out of the circuit to provide a $\frac{1}{2}$ bias voltage level for the 1:2 multiplex configuration.

6.3 LCD voltage selector

The LCD voltage selector co-ordinates the multiplexing of the LCD in accordance with the selected LCD drive configuration. The operation of the voltage selector is controlled by MODE SET commands from the command decoder.

The biasing configurations that apply to the preferred modes of operation, together with the biasing characteristics as functions of V_{OP} and the resulting discrimination ratios (D), are shown in Table 5.

Universal LCD driver for low multiplex rates

A practical value for V_{OP} is determined by equating $V_{OFF(rms)}$ with a defined LCD threshold voltage (V_{TH}), typically when the LCD exhibits approximately 10% contrast. In the static drive mode a suitable choice is $V_{OP} > 3V_{TH}$.

Multiplex drive ratios of 1:3 and 1:4 with $\frac{1}{2}$ bias are possible but the discrimination and hence the contrast ratios are smaller e.g.:

$$\sqrt{3} = 1.732$$
 for 1:3 multiplex or $\left(\frac{\sqrt{21}}{3} = 1.528\right)$ for 1:4 multiplex

The advantage of these modes is a reduction of the LCD full-scale voltage V_{OP} as follows:

• 1:3 multiplex (
$$\frac{1}{2}$$
 bias): $V_{OP} = \sqrt{6} \times V_{OFF(rms)} = 2.449 V_{OFF(rms)}$

• 1:4 multiplex (½ bias):
$$V_{OP} = \left\lceil \frac{(4 \times \sqrt{3})}{3} \right\rceil = 2.309 V_{OFF(rms)}$$

These compare with $V_{OP} = 3 \times V_{OFF(rms)}$ when $\frac{1}{3}$ bias is used. Note: $V_{OP} = V_{LCD}$.

Table 5. Preferred LCD drive modes: summary of characteristics

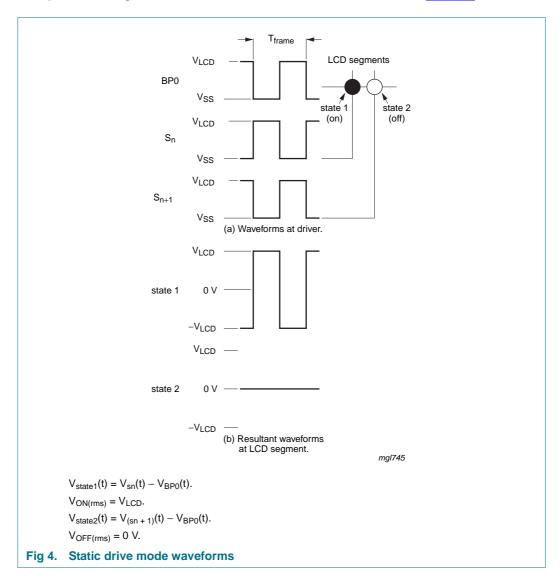
LCD drive mode	Number of:		LCD bias configuration	$\frac{V_{OFF(ms)}}{V_{OP}}$	$\frac{V_{ON(ms)}}{V_{OP}}$	$D = \frac{V_{ON(ms)}}{V_{OFF(ms)}}$
	Backplanes	Levels		OP	OF	OFF(ms)
static	1	2	static	0	1	∞
1:2	2	3	1/2	0.354	0.791	2.236
1:2	2	4	1/3	0.333	0.745	2.236
1:3	3	4	1/3	0.333	0.638	1.915
1:4	4	4	1/3	0.333	0.577	1.732

6.4 LCD drive mode waveforms

6.4.1 Static drive mode

The static LCD drive mode is used when a single backplane is provided in the LCD. Backplane and segment drive waveforms for this mode are shown in Figure 4.

Universal LCD driver for low multiplex rates

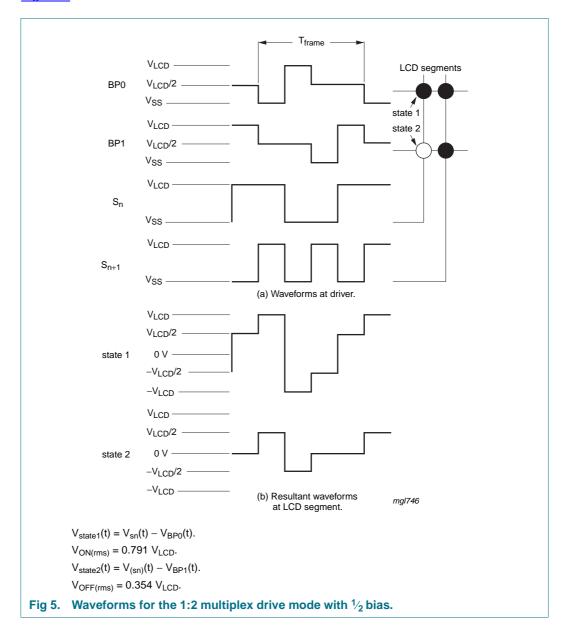


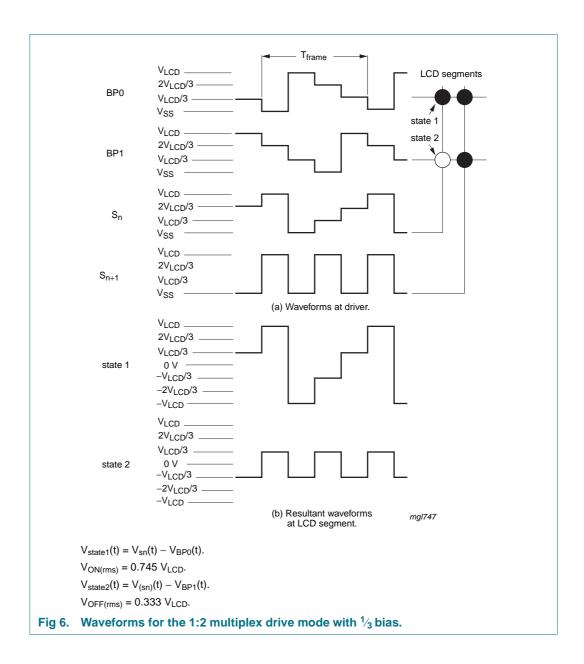
NXP Semiconductors

Universal LCD driver for low multiplex rates

6.4.2 1:2 Multiplex drive mode

When two backplanes are provided in the LCD, the 1:2 multiplex mode applies. The PCF8534 allows the use of $\frac{1}{2}$ bias or $\frac{1}{3}$ bias in this mode as shown in Figure 5 and Figure 6.

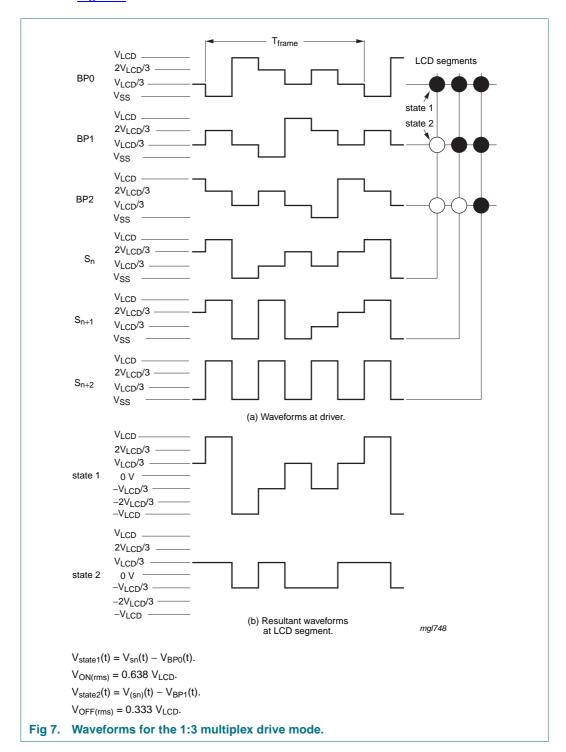




6.4.3 1:3 Multiplex drive mode

When three backplanes are provided in the LCD, the 1:3 multiplex drive mode applies, as shown in Figure 7.

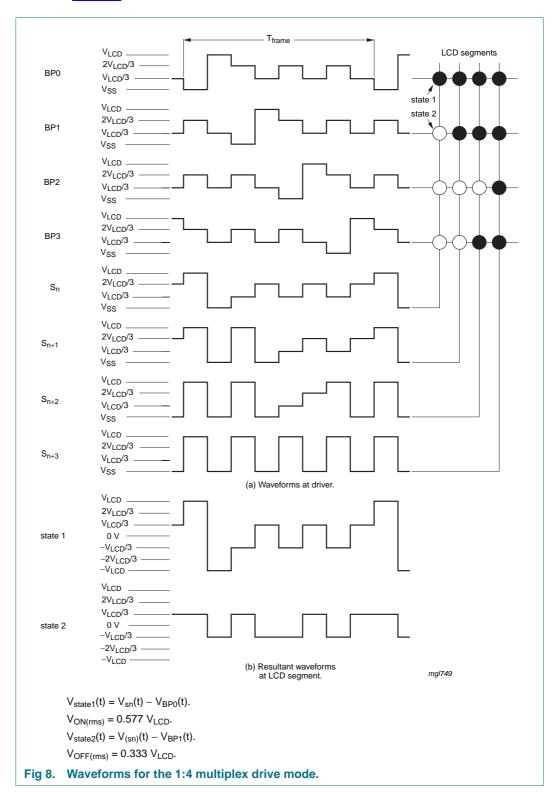
Universal LCD driver for low multiplex rates



Universal LCD driver for low multiplex rates

6.4.4 1:4 Multiplex drive mode

When four backplanes are provided in the LCD, the 1:4 multiplex drive mode applies, as shown in Figure 8.



www.DataSheet4U.com

Universal LCD driver for low multiplex rates

6.5 Oscillator

6.5.1 Internal clock

The internal logic and the LCD drive signals of the PCF8534 are timed either by the built-in oscillator or from an external clock. When the internal oscillator is used, you must connect pad OSC to V_{SS} . In this event, the output from pad CLK provides the clock signal for cascaded PCF8534's in the system. After power-up, SDA must be HIGH to guarantee that the clock starts.

6.5.2 External clock

The condition for external clock is made by tying pad OSC to V_{DD}; pad CLK then becomes the external clock input.

The clock frequency (f_{CLK}) determines the LCD frame frequency.

A clock signal must always be supplied to the device; removing the clock may freeze the LCD in a DC state.

6.6 Timing

The timing of the PCF8534 organizes the internal data flow of the device. This includes the transfer of display data from the display RAM to the display segment outputs. In cascaded applications the synchronization signal (SYNC) maintains the correct timing relationship between the PCF8534's in the system. The timing also generates the LCD frame frequency which it derives as an integer division of the clock frequency (see Table 6). The frame frequency is a fixed division of the internal clock or of the frequency applied to pad CLK when an external clock is used.

6.7 Display register

The display latch holds the display data while the corresponding multiplex signals are generated. There is a one-to-one relationship between the data in the display latch, the LCD segment outputs and one column of the display RAM.

6.8 Segment outputs

The LCD drive section includes 60 segment outputs (S0 to S59) which must be connected directly to the LCD. The segment output signals are generated in accordance with the multiplexed backplane signals and with data resident in the display latch. When less than 60 segment outputs are required the unused segment outputs must be left open-circuit.

6.9 Backplane outputs

The LCD drive section includes four backplane outputs BP0 to BP3 which must be connected directly to the LCD. The backplane output signals are generated in accordance with the selected LCD drive mode. If less than four backplane outputs are required the unused outputs can be left open-circuit. In the 1:3 multiplex drive mode BP3 carries the same signal as BP1, therefore these two adjacent outputs can be tied together to give enhanced drive capabilities. In the 1:2 multiplex drive mode BP0 and BP2, BP1 and BP3 respectively carry the same signals and may also be paired to increase the drive capabilities. In the static drive mode the same signal is carried by all four backplane outputs and they can be connected in parallel for very high drive requirements.

NXP Semiconductors

Universal LCD driver for low multiplex rates

6.10 Display RAM

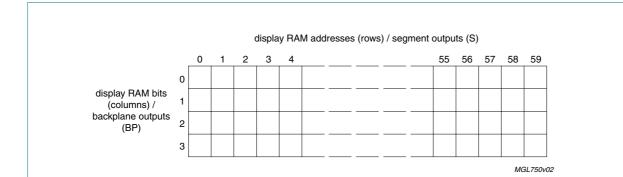
The display RAM is a static 60 x 4-bit RAM which stores LCD data. A logic 1 in the RAM bit map indicates the on-state of the corresponding LCD segment; similarly, a logic 0 indicates the off-state. There is a one-to-one correspondence between the RAM addresses and the segment outputs, and between the individual bits of a RAM word and the backplane outputs. The first RAM column corresponds to the 60 segments operated with respect to backplane BP0 (see Figure 9). In multiplexed LCD applications the segment data of the second, third and fourth column of the display RAM are time-multiplexed with BP1, BP2 and BP3 respectively.

When display data is transmitted to the PCF8534 the display bytes received are stored in the display RAM in accordance with the selected LCD drive mode. The data is stored as it arrives and does not wait for the acknowledge cycle as with the commands. Depending on the current mux mode data is stored singularly, in pairs, triplets or quadruplets. e.g. in 1:2 mux mode the RAM data is stored every second bit. To illustrate the filling order, an example of a 7-segment numeric display showing all drive modes is given in Figure 10; the RAM filling organization depicted applies equally to other LCD types. With reference to Figure 10, in the static drive mode the eight transmitted data bits are placed in bit 0 of eight successive display RAM addresses. In the 1:2 multiplex drive mode the eight transmitted data bits are placed in bits 0 and 1 of four successive display RAM addresses.

In the 1:3 multiplex drive mode these bits are placed in bits 0, 1 and 2 of three successive addresses, with bit 2 of the third address left unchanged. This last bit may, if necessary, be controlled by an additional transfer to this address but care should be taken to avoid overriding adjacent data because full bytes are always transmitted. In the 1:4 multiplex drive mode the eight transmitted data bits are placed in bits 0, 1, 2 and 3 of two successive display RAM addresses.

Table 6. LCD frame frequencies

Frame frequency	Nominal frame frequency (Hz)
$\frac{f_{CLK}}{24}$	64



Display RAM bit map showing direct relationship between backplane outputs, display RAM addresses and segment outputs, and between bits in a RAM word and backplane outputs.

www.DataSheet4U.com

Universal LCD driver for low multiplex rates

6.11 Data pointer

The addressing mechanism for the display RAM is realized using the data pointer. This allows the loading of an individual display data byte, or a series of display data bytes, into any location of the display RAM. The sequence commences with the initialization of the data pointer by the LOAD DATA POINTER command. Following this, an arriving data byte is stored starting at the display RAM address indicated by the data pointer thereby observing the filling order shown in Figure 10. The data pointer is automatically incremented in accordance with the chosen LCD configuration. That is, after each byte is stored, the contents of the data pointer are incremented by eight (static drive mode), by four (1:2 multiplex drive mode), by three (1:3 multiplex drive mode) or by two (1:4 multiplex drive mode). If an I²C-bus data access is terminated early then the state of the data pointer is unknown. The data pointer must be re-written prior to further RAM accesses.

6.12 Subaddress counter

The storage of display data is conditioned by the contents of the subaddress counter. Storage is allowed to take place only when the contents of the subaddress counter agree with the hardware subaddress applied to A0, A1 and A2. The subaddress counter value is defined by the DEVICE SELECT command. If the contents of the subaddress counter and the hardware subaddress do not agree then data storage is inhibited but the data pointer is incremented as if data storage had taken place.

The subaddress counter is also incremented when the data pointer overflows.

The storage arrangements described lead to extremely efficient data loading in cascaded applications. When a series of display bytes are sent to the display RAM, automatic wrap-over to the next PCF8534 occurs when the last RAM address is exceeded. Subaddressing across device boundaries is successful even if the change to the next device in the cascade occurs within a transmitted character (such as during the 27th display data byte transmitted in 1 : 3 multiplex mode).

The hardware subaddress should not be changed whilst the device is being accessed on the I²C-bus interface.

6.13 Output bank selector

The output bank selector selects one of the four bits per display RAM address for transfer to the display latch. The actual bit selected depends on the particular LCD drive mode in operation and on the instant in the multiplex sequence. In 1:4 multiplex, all RAM addresses of bit 0 are selected, these are followed by the contents of bit 1, bit 2 and then bit 3. Similarly in 1:3 multiplex, bits 0, 1 and 2 are selected sequentially. In 1:2 multiplex, bits 0 and 1 are selected and, in the static mode, bit 0 is selected.

The SYNC signal will reset these sequences to the following starting points; bit 3 for 1:4 multiplex, bit 2 for 1:3 multiplex, bit 1 for 1:2 multiplex and bit 0 for static mode.

The PCF8534 includes a RAM bank switching feature in the static and 1:2 multiplex drive modes. In the static drive mode, the BANK SELECT command may request the contents of bit 2 to be selected for display instead of the contents of bit 0. In the 1:2 drive mode, the contents of bits 2 and 3 may be selected instead of bits 0 and 1. This gives the provision for preparing display information in an alternative bank and to be able to switch to it once it is assembled.

www DataSheet4U com

Universal LCD driver for low multiplex rates

6.14 Input bank selector

The input bank selector loads display data into the display RAM in accordance with the selected LCD drive configuration. Display data can be loaded in bit 2 in static drive mode or in bits 2 and 3 in 1:2 drive mode by using the BANK SELECT command. The input bank selector functions independently to the output bank selector.

6.15 Blinker

The display blinking capabilities of the PCF8534 are very versatile. The whole display can be blinked at frequencies selected by the BLINK command. The blinking frequencies are integer multiples of the clock frequency. The ratios between the clock and blinking frequencies depend on the mode in which the device is operating, see Table 7.

An additional feature is for an arbitrary selection of LCD segments to be blinked. This applies to the static and 1:2 LCD drive modes and is implemented without any communication overheads. By means of the output bank selector, the displayed RAM banks are exchanged with alternate RAM banks at the blinking frequency. This mode can also be specified by the BLINK command.

In the 1:3 and 1:4 multiplex modes, where no alternate RAM bank is available, groups of LCD segments can be blinked by selectively changing the display RAM data at fixed time intervals.

If the entire display is to be blinked at a frequency other than the nominal blinking frequency, this can be effectively performed by resetting and setting the display enable bit E at the required rate using the MODE SET command.

Table 7. Blinking frequencies

Blinking mode	Normal operating mode ratio	Normal blinking frequency
Off	-	Blinking off
2 Hz	$\frac{f_{CLK}}{768}$	2 Hz
1 Hz	f _{CLK} 1536	1 Hz
0.5 Hz	f _{CLK} 3072	0.5 Hz

www.DataSheet4U.com

Preliminary datasheet

Universal LCD driver for low multiplex rates

drive mode	LCD segments	LCD backplanes	display RAM filling order	transmitted display byte
static	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	BP0 BP0	n n+1 n+2 n+3 n+4 n+5 n+6 n+7 bit/ 0 c b a f g e d DP BP 1 x x x x x x x x 2 x x x x x x x x 3 x x x x x x x x	MSB LSB
1 : 2 multiplex	S_{n-1} S_{n+1} S_{n+2} S_{n+3} S_{n	BP0 BP1	n n+1 n+2 n+3	MSB LSB
1 : 3 multiplex	S _{n+1} - a b S _n	BP1 BP2	bit/ 0 b a f DP d e 2 c g x 3 x x x x	MSB LSB
1 : 4 multiplex	S _n a b g e c DP	BP0 BP2 BP1 BP3	n n+1 bit/ 0 a f BP 1 c e 2 b g 3 DP d	MSB LSB

mgl751

X = data bit unchanged

Fig 10. Relationship between LCD layout, drive mode, display RAM filling order and display data transmitted over the I²C bus.

NXP Semiconductors

Universal LCD driver for low multiplex rates

Application design-in information

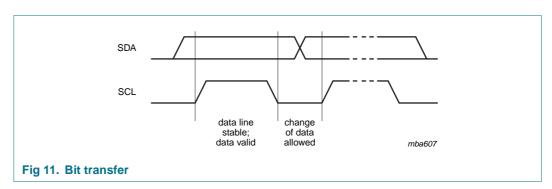
7.1 Characteristics of the I²C bus

The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial Clock Line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer is initiated only when the bus is not busy.

7.2 Bit transfer

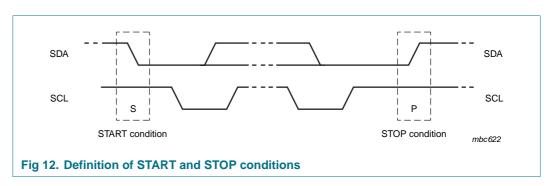
One data bit is transferred during each clock pulse.

The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal. Bit transfer is illustrated in Figure 11.



7.3 START and STOP conditions

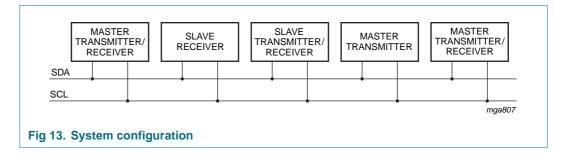
Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in Figure 12.



7.4 System configuration

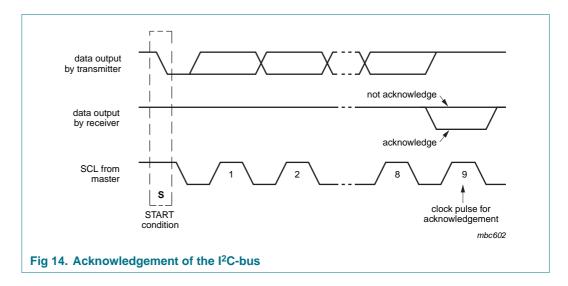
A device generating a message is a 'transmitter', a device receiving a message is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves'. The system configuration is illustrated in Figure 13.

Universal LCD driver for low multiplex rates



7.5 Acknowledge

The number of data bytes transferred between the START and STOP conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition. Acknowledgement on the I²C-bus is illustrated in Figure 14.



7.6 PCF8534 I²C-bus controller

The PCF8534 acts as an I²C-bus slave receiver. It does not initiate I²C-bus transfers or transmit data to an I²C-bus master receiver. The only data output from the PCF8534 are the acknowledge signals of the selected devices. Device selection depends on the I²C-bus slave address, on the transferred command data and on the hardware subaddress.

Universal LCD driver for low multiplex rates

In single device application, the hardware subaddress inputs A0, A1 and A2 are normally tied to V_{SS} which defines the hardware subaddress 0. In multiple device applications A0, A1 and A2 are tied to V_{SS} or V_{DD} in accordance with a binary coding scheme such that no two devices with a common I^2C -bus slave address have the same hardware subaddress.

7.7 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

7.8 I²C-bus protocol

Two I²C-bus slave addresses (01110000 and 01110010) are reserved for the PCF8534. The least significant bit of the slave address that a PCF8534 will respond to is defined by the level tied at its input SA0. The PCF8534 is a write only device and will not respond to a read access. Therefore, two types of PCF8534 can be distinguished on the same I²C-bus which allows:

- 1. Up to 16 PCF8534's on the same I²C-bus for very large LCD applications
- 2. The use of two types of LCD multiplex on the same I²C-bus.

The I²C-bus protocol is shown in <u>Figure 15</u>. The sequence is initiated with a START condition (S) from the I²C-bus master which is followed by one of the two PCF8534 slave addresses available. All PCF8534's with the corresponding SA0 level acknowledge in parallel to the slave address, but all PCF8534's with the alternative SA0 level ignore the whole I²C-bus transfer.

After acknowledgement, a control byte follows which defines if the next byte is RAM or command information. The control byte also defines if the next following byte is a control byte or further RAM/command data.

In this way it is possible to configure the device then fill the display RAM with little overhead.

The command bytes and control bytes are also acknowledged by all addressed PCF8534's connected to the bus.

The display bytes are stored in the display RAM at the address specified by the data pointer and the subaddress counter. Both data pointer and subaddress counter are automatically updated and the data is directed to the intended PCF8534 device.

The acknowledgement after each byte is made only by the (A0, A1 and A2) addressed PCF8534. After the last display byte, the I^2C -bus master issues a STOP condition (P). Alternatively a START may be issued to RESTART an I^2C -bus access.

www.DataSheet4U.com

Preliminary datasheet

CF8534

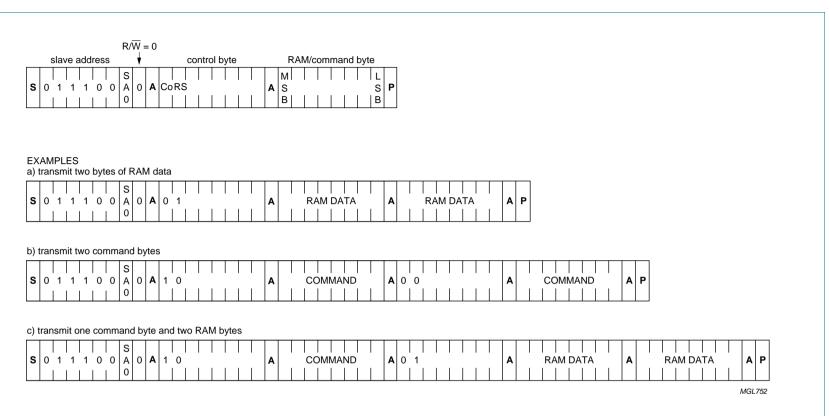
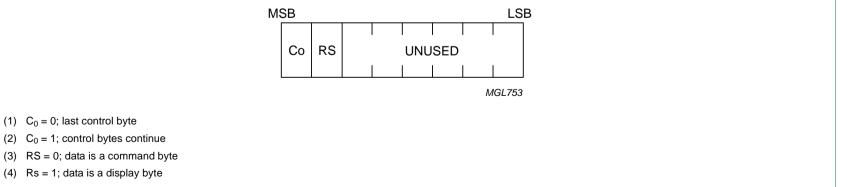


Fig 15. I²C-bus protocol



Universal LCD driver for low multiplex rates

7.9 Command decoder

The command decoder identifies command bytes that arrive on the I²C-bus. The five commands available to the PCF8534 are defined in Table 8.

Table 8. Definition of PCF8534 commands

Command	OPCODE	Options	Description
Mode set	1 1 0 0 E B M1 M0	Table 9	defines LCD drive mode
		Table 10	defines LCD bias configuration
		Table 11	defines display status; the possibility to disable the display allows implementation of blinking under external control
Load data pointer	0 P6 P5 P4 P3 P2 P1 P0	Table 12	7 bits of immediate data, bits P6 to P0, are transferred to the data pointer to define one of 8 hardware subaddresses
Device select	1 1 1 0 0 A2 A1 A0	Table 13	3 bits of immediate data, bits A0 to A3 are transferred to the subaddress counter to define one of 8 hardware subaddresses
Bank select	1111010	Table 14	defines input bank selection (storage of arriving display data)
		Table 15	defines output bank selection (retrieval of LCD display data); the BANK SELECT command has no effect in 1:3 or 1:4 multiplex drive modes
Blink	1 1 1 1 0 A BF BF	Table 16	defines the blinking frequency
	1 0	Table 17	selects the blinking mode; normal operation with frequency set by BF1, BF0 or blinking by alteration of display RAM banks. Alteration blinking does not apply in 1:3 or 1:4 multiplex drive modes.

Table 9. Mode set option 1

LCD drive mode		Bits		
Drive mode	Backplane	M1	M0	
static	1 BP	0	1	
1:2	MUX (2BP)	1	0	
1:3	MUX (3BP)	1	1	
1:4	MUX (4BP)	0	0	

Table 10. Mode set option 2

LCD bias	Bit B
$\frac{1}{3}$ bias	0
$\frac{1}{2}$ bias	1

Table 11. Mode set option 3

Display status	Bit E
disabled (blank)	0
enabled	1

NXP Semiconductors

Universal LCD driver for low multiplex rates

Table 12. Load data pointer option 1

Description	Bits						
7 bit ordinary value of 0 to 59	P6	P5	P4	P3	P2	P1	P0

Table 13. Device selected option 1

Description	Bits		
3 bit binary value of 0 to 7	A2	A1	A0

Table 14. Blank select option 1 (input)

Static	1:2 MUX	Bit I
RAM bit 0	RAM bits 0 and 1	0
RAM bit 2	RAM bits 2 and 3	1

Table 15. Blank select option 2 (output)

Static	1:2 MUX	Bit O
RAM bit 0	RAM bits 0 and 1	0
RAM bit 2	RAM bits 2 and 3	1

Table 16. Blink option 1

Blink frequency	Bits	
	BF1	BF0
off	0	0
2 Hz	0	1
1 Hz	1	0
1.5 Hz	1	1

Table 17. Blink option 2

Blink mode	Bit A	
normal blinking	0	<u>[1]</u>
alteration blinking	1	

^[1] Normal blinking is assumed when the multiplex rates 1:3 or 1:4 are selected.

7.10 Display controller

The display controller executes the commands identified by the command decoder. It contains the status registers of the PCF8534 and co-ordinates their effects. The controller is also responsible for loading display data into the display RAM as required by the filling order.

7.11 Cascaded operation

In large display configurations, up to 16 PCF8534's can be distinguished on the same I²C-bus by using the 3-bit hardware subaddress (A0, A1 and A2) and the programmable I²C-bus slave address (SA0). When cascaded PCF8534's are synchronized they can share the backplane signals from one of the devices in the cascade. Such an arrangement is cost-effective in large LCD applications since the backplane outputs of

Universal LCD driver for low multiplex rates

only one device need to be through-plated to the backplane electrodes of the display. The other PCF8534's of the cascade contribute additional segment outputs but their backplane outputs are left open-circuit (see Figure 17).

The SYNC line is provided to maintain the correct synchronization between all cascaded PCF8534's. This synchronization is guaranteed after the power-on reset. The only time that SYNC is likely to be needed is if synchronization is accidentally lost (e.g. by noise in adverse electrical environments, or by the definition of a multiplex mode when PCF8534's with different SA0 levels are cascaded). SYNC is organized as an input / output pad; the output selection being realized as an open-drain driver with an internal pull-up resistor. A PCF8534 asserts the SYNC line at the onset of its last active backplane signal and monitors the SYNC line at all other times. If synchronization in the cascade is lost, it is restored by the first PCF8534 to assert SYNC. The timing relationship between the backplane waveforms and the SYNC signal for the various drive modes of the PCF8534 are shown in Figure 18.

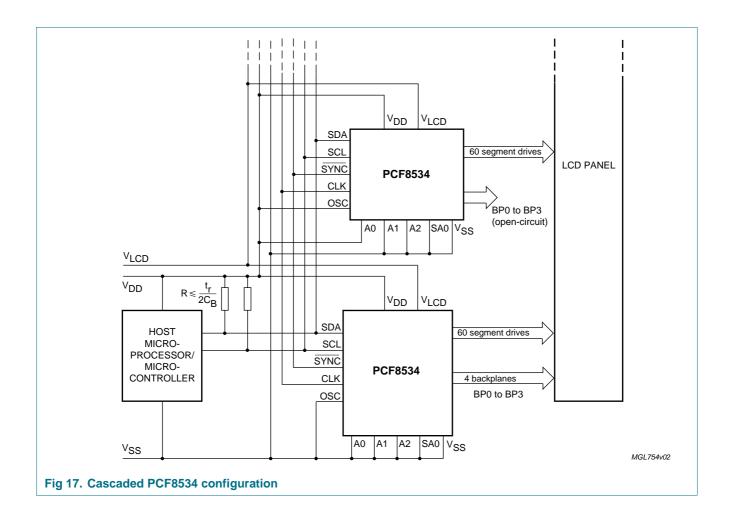
The contact resistance between the SYNC pads of cascaded devices must be controlled. If the resistance is too high then the device will not be able to synchronize properly.

Table 18 shows the limiting values for contact resistance.

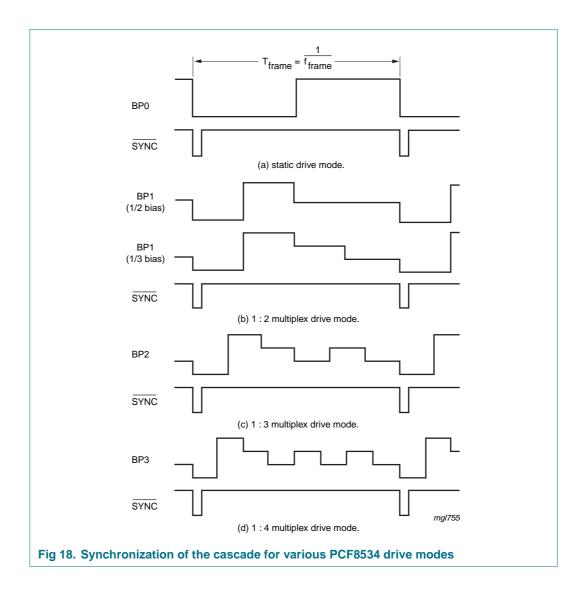
Table 18. SYNC contact resistance

Number of devices	Maximum contact resistance
2	6000 Ω
3 to 5	2200 Ω
6 to 10	1200 Ω
11 to 16	700 Ω

Universal LCD driver for low multiplex rates



Universal LCD driver for low multiplex rates



www.DataSheet4U.com

Universal LCD driver for low multiplex rates

8. Limiting values

Table 19. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Min	Max	Unit
V_{DD}	supply voltage	-0.5	+6.5	V
I_{DD}	supply current	-50	+50	mA
V_{LCD}	LCD supply voltage	$V_{SS}-0.5$	+7.5	V
I _{LCD}	LCD supply current	-50	+50	mA
I _{SS}	negative supply current	-50	+50	mA
V _{I(n)}	input voltage on pads SDA, SCL, CLK, SYNC, SA0, OSC and A0 to A2	V _{SS} – 0.5	V _{DD} + 0.5	V
V _{O(n)}	output voltage on pads s= to S59 and BP0 to BP3	$V_{SS} - 0.5$	V _{LCD} + 0.5	V
I _I	DC input current	-10	+10	mA
Io	DC output current	-10	+10	mA
P _{TOT}	total power dissipation	-	400	mW
P / out	power dissipation per output	-	100	mW
T_{STG}	storage temperature	-65	+150	°C

8.1 ESD values

- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 2000 V CDM per JESD22-C101.
- Latch-up testing is done to JEDEC standard JESD78 which exceeds 100 mA.

9. Static characteristics

Table 20. Static characteristics

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 to 6.5 V; T_{AMB} = -40 to +85°C; unless otherwise specified

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Supplies							
V_{DD}	supply voltage			1.8	-	5.5	V
V_{LCD}	LCD supply voltage			2.5	-	6.5	μΑ
I_{DD}	supply current	f _{CLK} = 1536 Hz	<u>[1]</u>	-	8	20	μΑ
I _{LCD}	LCD supply current	f _{CLK} = 1536 Hz	<u>[1]</u>	-	24	60	μΑ
Logic							
V _{IL}	Low-level input voltage			V_{SS}	-	0.3 V _{DD}	V
V_{IH}	High-level input voltage			$0.7 V_{DD}$	-	V_{DD}	V
I _{OL1}	Low-level output current on pads CLK and SYNC	$V_{OL} = 0.4 \text{ V}; V_{DD} = 5 \text{ V}$		1	-	-	mA

Table 20. Static characteristics

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 to 6.5 V; T_{AMB} = -40 to +85°C; unless otherwise specified

. 00	0.01, 1.33	=10 to 0.0 1, 1 AIVID 10 to 100	2, 2300 00			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{OH1}	High-level output current pad CLK	$V_{OH} = 4.6 \text{ V}; V_{DD} = 5 \text{ v}$	-1	-	-	mA
I _{OL2}	Low-level output current pad SDA	$V_{OL} = 0.4 \text{ V}; V_{DD} = 5 \text{ V}$	3	-	-	mA
I _{L1}	leakage current pads SA0, A0 to A2, CLK, SDA and SCL	$V_1 = V_{DD}$ or V_{SS}	-1	-	+1	μΑ
I_{L2}	leakage current pad OSC	$V_1 = V_{DD}$	-1	-	+1	μΑ
C ₁	input capacitance		[2] _	-	7	pF
V_{POR}	power on reset voltage level		1.0	1.3	1.6	V
LCD outpu	uts					
V_{BP}	DC voltage component on pads BP0 to BP3	C _{BP} = 35 nF	-100	-	+100	mV
V _S	DC voltage component on pads S0 to S59	C _S = 5 nF	-100	-	+100	mV
R _{BP}	output resistance at pads BP0 to BP3	$V_{LCD} = 5 \text{ V}$	<u>[3]</u> _	1.5	10	kΩ
R _S	output resistance at pads S0 to S59	$V_{LCD} = 5 \text{ V}$	[3] -	6.0	13.5	kΩ

^[1] LCD outputs are open circuit; inputs at V_{SS} or V_{DD}; external clock with 50% duty factor; I²C-bus inactive.

10. Dynamic characteristics

Table 21. Dynamic characteristics

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 to 6.5 V; T_{AMB} = -40 to +85°C; unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{CLK(int)}	oscillator frequency on pad CLK (internal clock)	$V_{DD} = 5 V$	<u>[1]</u> 960	1536	3046	Hz
f _{CLK(ext)}	oscillator frequency on pad CLK (external clock)	$V_{DD} = 5 V$	797	1536	3046	Hz
t _{CLKH}	input CLK HIGH time		130	-	-	μs
t _{CLKL}	input CLK LOW time		130	-	-	μs
t _r	CLK rise time		-	-	-	ns
t _f	CLK fall time		-	-	-	ns
t _{d(p)SYNC}	SYNC propagation delay time		-	30	-	ns
t _{SYNCL}	SYNC LOW time		1	-	-	μs
t _{d(PLCD)}	driver delays with test loads	$V_{LCD} = 5 V$	-	-	30	μs
Timing ch	aracteristic: I ² C bus		[2]			
f _{SCL}	SCL clock frequency		-	-	400	kHz
t _{BUF}	bus free time between a stop and a start		1.3	-	-	μs
PCF8534 0				e e	NXP B.V. 2007. A	III rights reserved

^[2] Not tested, design spec only.

^[3] Outputs measured individually and sequentially.

Table 21. Dynamic characteristics

 V_{DD} = 1.8 to 5.5 V; V_{SS} = 0 V; V_{LCD} = 2.5 to 6.5 V; T_{AMB} = -40 to +85°C; unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{HD;STA}	start condition hold time		0.6	-	-	μs
t _{SU;STA}	set-up time for a repeated start condition		0.6	-	-	μs
t_{LOW}	SCL LOW time		1.3	-	-	μs
t _{HIGH}	SCL HIGH time		0.6	-	-	μs
t _r	SCL and SDA rise time		-	-	0.3	μs
t _f	SCL and SDA fall time		-		0.3	μs
C _b	capacitive bus line load		-	-	400	pF
t _{SU;DAT}	data set-up time		100			ns
t _{HD;DAT}	data hold time		0	-	-	ns
t _{SU;STO}	set up time for stop condition		0.6	-	-	μs
t _{SW}	tolerable spike width on bus		-	-	50	ns

- [1] Typical output duty cycle of 50%.
- [2] All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD}.

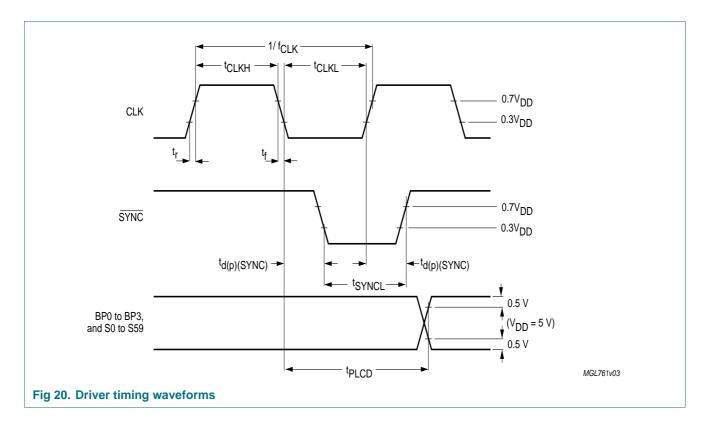
$$\overline{\text{SYNC}} \xrightarrow{\qquad \qquad } V_{DD}$$

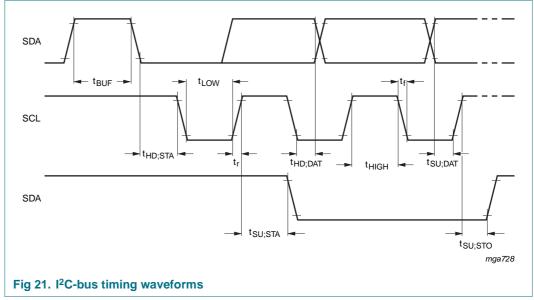
$$CLK \xrightarrow{\qquad \qquad } 0.5V_{DD} \qquad \overline{\text{SDA}}, \xrightarrow{\qquad \qquad } 1.5 \text{ k}\Omega \\ (2\%) \qquad \qquad CDD \qquad \overline{\text{SCL}} \xrightarrow{\qquad } V_{DD}$$

$$BP0 \text{ to BP3, and } 1 \text{ nF} \\ S0 \text{ to S59} \qquad \overline{\qquad } V_{SS}$$

$$MGS120v02$$
Fig 19. Test loads

Universal LCD driver for low multiplex rates





11. Package outline

LQFP80: plastic low profile quad flat package; 80 leads; body 12 x 12 x 1.4 mm

SOT315-1

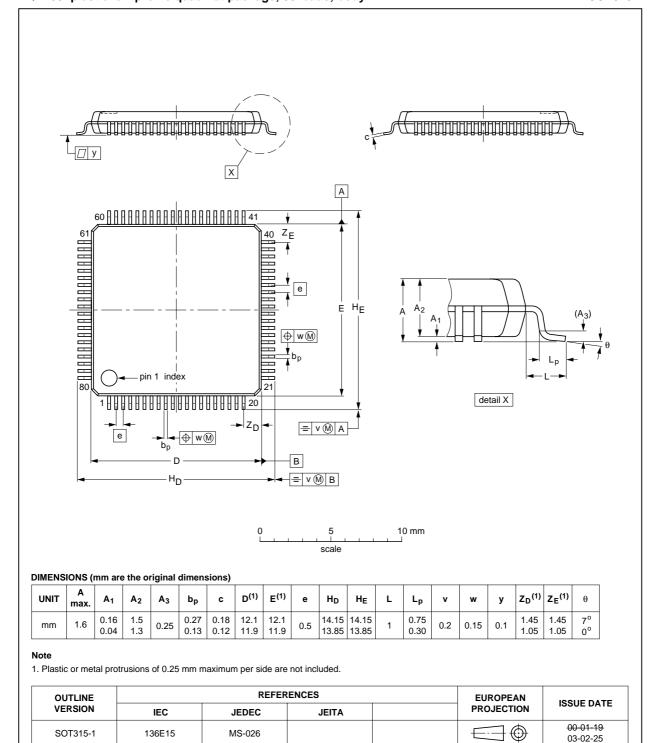
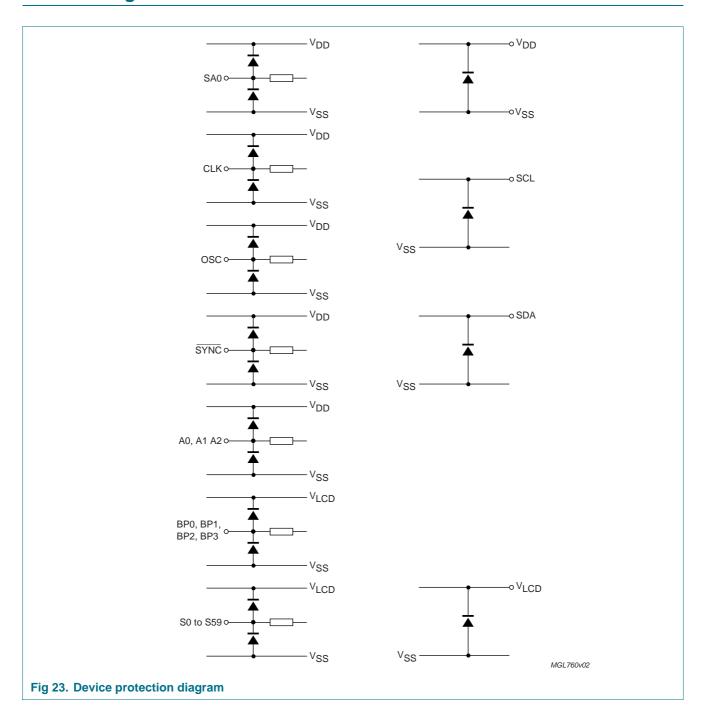


Fig 22. Package outline LQFP80

NXP Semiconductors

Universal LCD driver for low multiplex rates

12. Handling information



Universal LCD driver for low multiplex rates

13. Soldering

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

13.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

13.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus PbSn soldering

13.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

www DataSheet4U com

13.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 24</u>) than a PbSn process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 22 and 23

Table 22. SnPb eutectic process (from J-STD-020C)

Package thickness (mm)	Package reflow temperature (°C) Volume (mm³)		
	< 350	≥ 350	
< 2.5	235	220	
≥ 2.5	220	220	

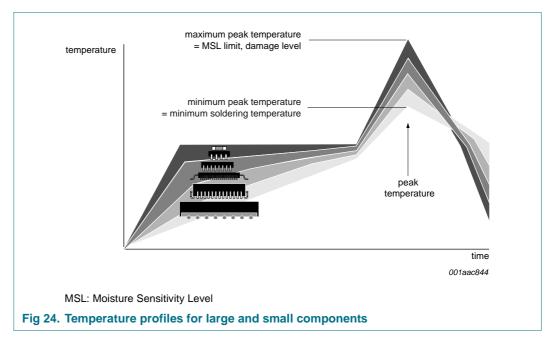
Table 23. Lead-free process (from J-STD-020C)

Package thickness (mm) Package reflow temperature (°C)				
	Volume (mm³)			
	< 350	350 to 2000	> 2000	
< 1.6	260	260	260	
1.6 to 2.5	260	250	245	
> 2.5	250	245	245	

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 24.

Universal LCD driver for low multiplex rates



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

Universal LCD driver for low multiplex rates

14. Revision history

Table 24. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCF8534_00.04	tbd	Preliminary		PCF8534_00.03
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	with the new identity
	 Legal texts have been adapted to the new company name where appropriate. 			
	• <u>Table 21</u> : cl	ock oscillator frequency (ad	ded external)	
PCF8534_00.03	20060829	Objective		PCF8534_00.02
Modifications:	• <u>Table 1</u> :add	ed column for 'Topside mar	k'	
	 Section 8.1 	: added ESD values.		
PCF8534_00.02	20060725	Objective		PCF8534_00.01
Modifications:	 transfer to 	TDM format		
PCF8534_00.01	20060628	Objective		first release

www DataSheet4U com

Universal LCD driver for low multiplex rates

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

15.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfunction of a NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For additional information, please visit: http://www.nxp.com

For sales office addresses, send an email to: salesaddresses@nxp.com

www.DataSheet4U.com

Universal LCD driver for low multiplex rates

Notes

12 13.1 13.2 13.3 13.4 14 15.1 15.2 15.3 15.4 16 17

www.DataSheet4U.com

Universal LCD driver for low multiplex rates

17. Contents

1	General description	. 1
2	Features	. 1
3	Ordering information	. 2
4	Block diagram	. 3
5	Pinning information	
5.1	Pinning	. 4
5.2	Pin description	
6	Functional description	. 6
6.1	Power-on-reset	. 7
6.2	LCD bias generator	. 7
6.3	LCD voltage selector	. 7
6.4	LCD drive mode waveforms	. 9
6.4.1	Static drive mode	. 9
6.4.2	1:2 Multiplex drive mode	10
6.4.3	1:3 Multiplex drive mode	12
6.4.4	1:4 Multiplex drive mode	13
6.5	Oscillator	14
6.5.1	Internal clock	14
6.5.2	External clock	14
6.6	Timing	14
6.7	Display register	14
6.8	Segment outputs	14
6.9	Backplane outputs	14
6.10	Display RAM	15
6.11	Data pointer	16
6.12	Subaddress counter	16
6.13	Output bank selector	16
6.14	Input bank selector	17
6.15	Blinker	17
7	Application design-in information	19
7.1	Characteristics of the I ² C bus	19
7.2	Bit transfer	19
7.3	START and STOP conditions	19
7.4	System configuration	19
7.5	Acknowledge	20
7.6	PCF8534 I2C-bus controller	20
7.7	Input filters	21
7.8	I2C-bus protocol	
7.9	Command decoder	
7.10	Display controller	24
7.11	Cascaded operation	24
8	Limiting values	28
8.1	ESD values	28
9	Static characteristics	28
10	Dynamic characteristics	29
11	Package outline	32

Handling information	33
Soldering	34
Introduction to soldering	34
Wave and reflow soldering	34
Wave soldering	34
Reflow soldering	35
Revision history	37
Legal information	38
Data sheet status	38
Definitions	38
Disclaimers	38
Trademarks	38
Contact information	38
Orminate	40

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

founded by



© NXP B.V. 2007. All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com